

Features

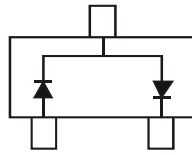
- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automated Insertion
- High Conductance
- High Reverse Breakdown Voltage Rating
- **Lead, Halogen and Antimony Free, RoHS Compliant "Green" Device (Notes 3 and 4)**

Mechanical Data

- Case: SOT-23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagram
- Marking Information: See Diagrams Below and Page 2
- Ordering Information: See Page 2
- Weight: 0.008 grams (approximate)

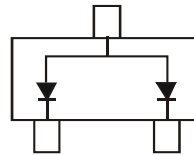


TOP VIEW

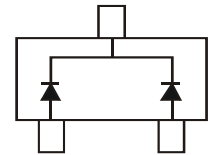


MMBD3004S Marking: KAE

SOT-23



MMBD3004A Marking: KAD



MMBD3004C Marking: KAC

Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V_{RRM}	350	V
Working Peak Reverse Voltage	V_{RWM}	300	V
DC Blocking Voltage	V_R		V
RMS Reverse Voltage	$V_{R(RMS)}$	212	V
Forward Continuous Current (Note 2)	I_F	225	mA
Peak Repetitive Forward Current (Note 2)	I_{FRM}	625	mA
Non-Repetitive Peak Forward Surge Current @ $t = 1.0\mu\text{s}$	I_{FSM}	4.0	A
@ $t = 1.0\text{s}$		1.0	

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 2)	P_D	350	mW
Thermal Resistance Junction to Ambient Air (Note 2)	$R_{\theta JA}$	357	$^\circ\text{C}/\text{W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +150	$^\circ\text{C}$

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 1)	$V_{(BR)R}$	350	—	—	V	$I_R = 150\mu\text{A}$
Forward Voltage (Note 1)	V_F	—	0.78	0.87	V	$I_F = 20\text{mA}$
			0.93	1.0		$I_F = 100\text{mA}$
			1.03	1.25		$I_F = 200\text{mA}$
Reverse Current (Note 1)	I_R	—	30	100	nA	$V_R = 240\text{V}$
			35	100		μA
Total Capacitance	C_T	—	1.0	5.0	pF	$V_R = 0\text{V}, f = 1.0\text{MHz}$
Reverse Recovery Time	t_{rr}	—	—	50	ns	$I_F = I_R = 30\text{mA}$, $I_{rr} = 3.0\text{mA}, R_L = 100\Omega$

- Notes:
1. Short duration pulse test used to minimize self-heating effect.
 2. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.
 3. No purposefully added lead. Halogen and Antimony Free.
 4. Product manufactured with Data Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb_2O_3 Fire Retardants.

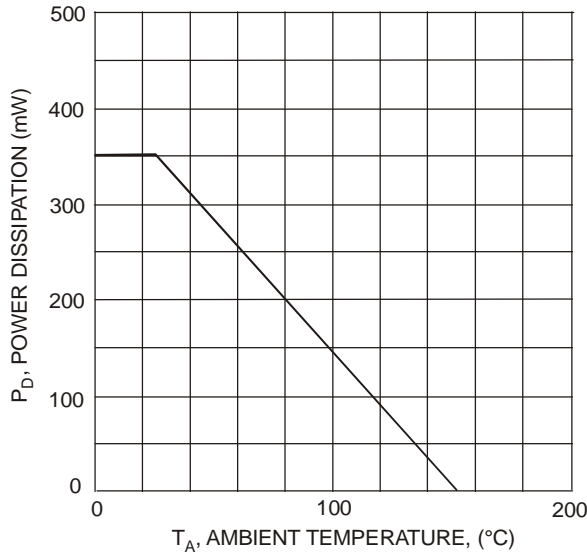


Fig. 1 Power Derating Curve, Total Package

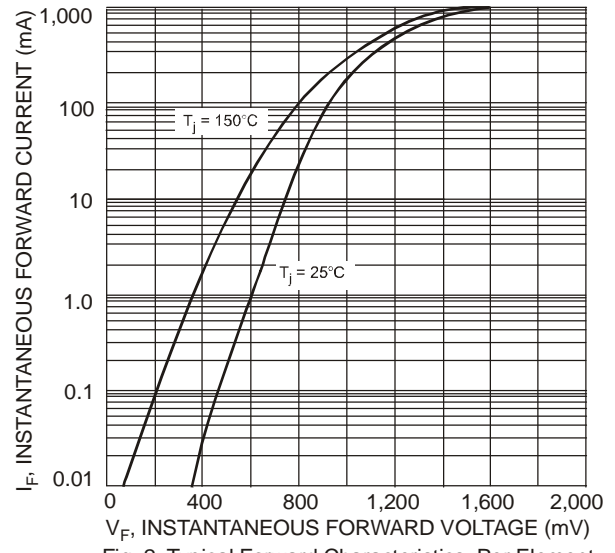


Fig. 2 Typical Forward Characteristics, Per Element

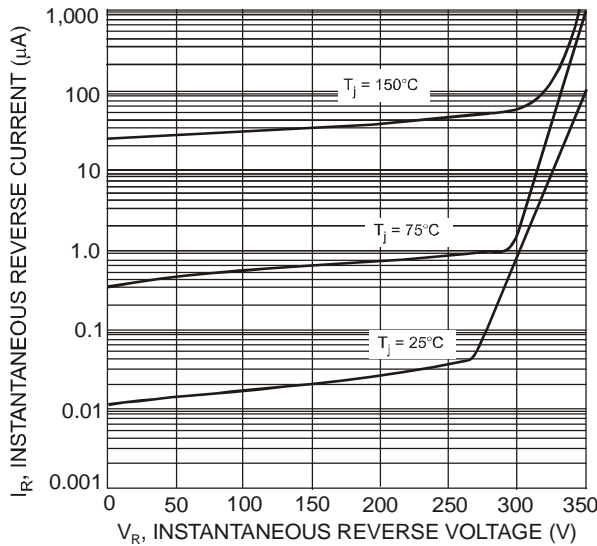


Fig. 3 Typical Reverse Characteristics, Per Element

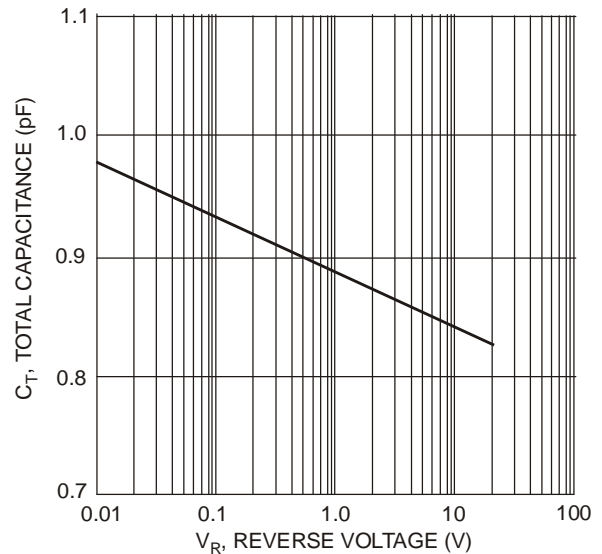


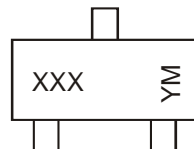
Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

Ordering Information (Note 5)

Part Number	Case	Packaging
MMBD3004S-7-F	SOT-23	3000/Tape & Reel
MMBD3004A-7-F	SOT-23	3000/Tape & Reel
MMBD3004C-7-F	SOT-23	3000/Tape & Reel

Notes: 5. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information



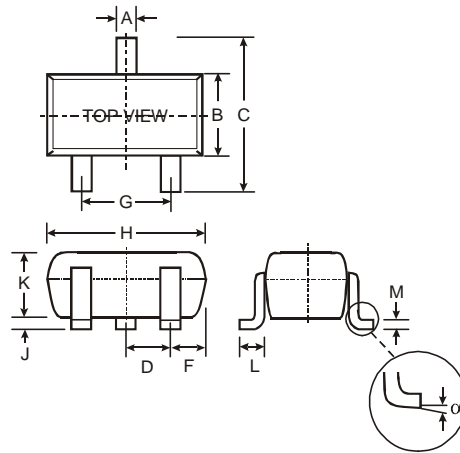
xxx = Product Type Marking Code, See Page 1 Diagrams
 YM = Date Code Marking
 Y = Year ex: T = 2006
 M = Month ex: 9 = September

Date Code Key

Year	2006	2007	2008	2009	2010	2011	2012
Code	T	U	V	W	X	Y	Z

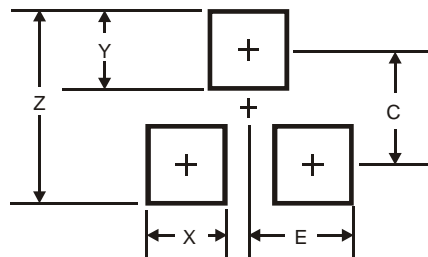
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Package Outline Dimensions



SOT-23		
Dim	Min	Max
A	0.37	0.51
B	1.20	1.40
C	2.30	2.50
D	0.89	1.03
F	0.45	0.60
G	1.78	2.05
H	2.80	3.00
J	0.013	0.10
K	0.903	1.10
L	0.45	0.61
M	0.085	0.180
α	0°	8°
All Dimensions in mm		

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
X	0.8
Y	0.9
C	2.0
E	1.35

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